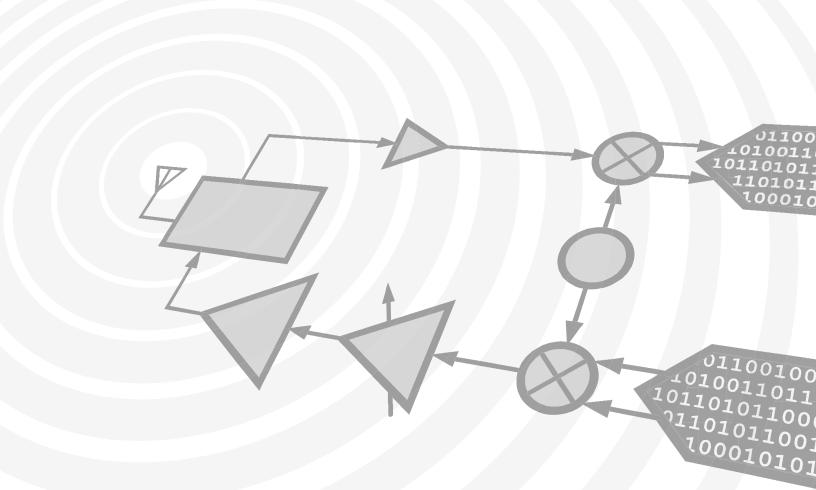




# Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



# **HMC272A\* Product Page Quick Links**

Last Content Update: 11/01/2016

# Comparable Parts

View a parametric search of comparable parts

# Evaluation Kits <a> □</a>

• HMC272AMS8 Evaluation Board

# Documentation <a>□</a>

#### **Data Sheet**

• HMC272A Data Sheet

# Tools and Simulations

• HMC272A S-Parameters

## Reference Materials

#### **Quality Documentation**

PCN: MS, QS, SOT, SOIC packages - Sn/Pb plating vendor change

# Design Resources -

- HMC272A Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

# Discussions <a>□</a>

View all HMC272A EngineerZone Discussions

# Sample and Buy 🖳

Visit the product page to see pricing options

# Technical Support <a> Image: Decided to the content of the content

Submit a technical question or find your regional support number

<sup>\*</sup> This page was dynamically generated by Analog Devices, Inc. and inserted into this data sheet. Note: Dynamic changes to the content on this page does not constitute a change to the revision number of the product data sheet. This content may be frequently modified.





# **HMC272AMS8/272AMS8E**

GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz



#### **Typical Applications**

The HMC272AMS8 / HMC272AMS8E is ideal for:

- Up or Down Converter for PCS
- W-CDMA
- 2.4 GHz ISM
- MMDS

#### **Features**

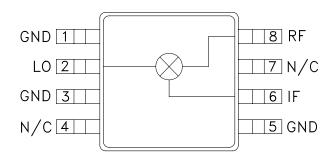
RoHS Compliant Product

Ultra Small Package: MSOP8

LO / RF Isolation: 32 dB

Input IP3: +20 dBm

#### **Functional Diagram**



#### **General Description**

The HMC272AMS8 & HMC272AMS8E are general purpose ultra miniature single balanced mixers in 8 lead plastic surface mount Mini Small Outline Packages (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and a novel planar transformer balun on the chip. The RF port is balanced via the MMIC balun while the LO port is connected directly to the diodes. The consistent MMIC performance will improve system operation and assure regulatory compliance.

## Electrical Specifications, $T_A = +25^{\circ}$ C, As a Function of IF Frequency

Parameter	LO = +10 dBm IF = 100 MHz		LO = +10 dBm IF = 400 MHz			Units	
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Frequency Range, RF & LO		2 - 3			1.7 - 2.8		GHz
Frequency Range, IF		DC - 0.8			DC - 0.8		GHz
Conversion Loss		9	10.5		9	11	dB
Noise Figure (SSB)		9	10.5		9	11	dB
LO to RF Isolation	22	30		24	32		dB
LO to IF Isolation	12	20		11	18		dB
IP3 (Input)	17	21		16	20		dBm
1 dB Compression (Input)	8	11		7	10		dBm

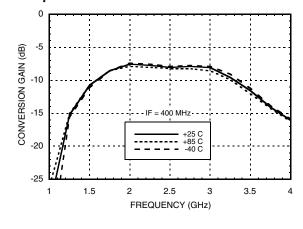
**BALANCED MIXER, 1.7 - 3.0 GHz** 

**GaAs MMIC SMT SINGLE** 

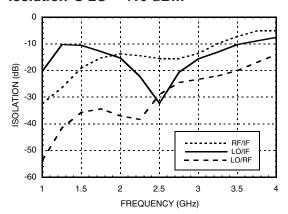




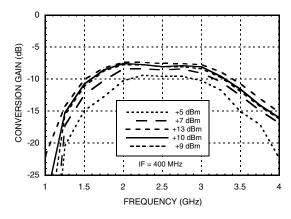
# Conversion Gain vs. Temperature @ LO = +10 dBm



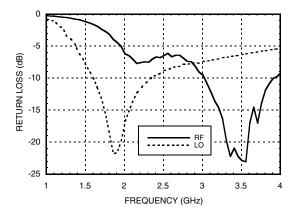
#### Isolation @ LO = +10 dBm



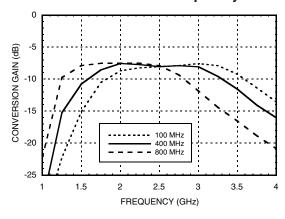
#### Conversion Gain vs. LO Drive



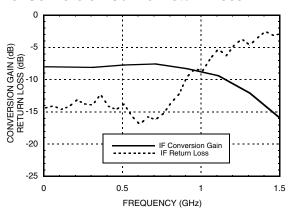
Return Loss @ LO = +10 dBm



#### Conversion Gain vs. IF Frequency



IF Bandwidth @ LO = +10 dBm vs. Conversion Gain & Return Loss



10

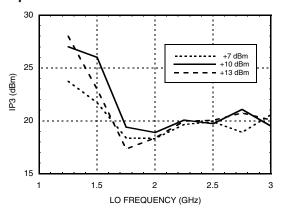


# **HMC272AMS8 / 272AMS8E**

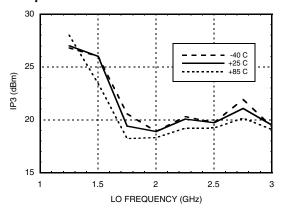
# GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz



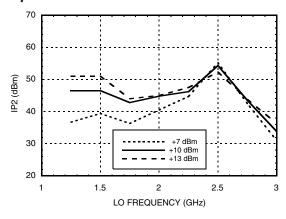
#### Input IP3 vs. LO Drive



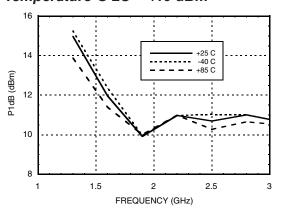
Input IP3 vs. Temperature @ LO = +10 dBm



## Input IP2 vs. LO Drive



P1dB vs.
Temperature @ LO = +10 dBm





# **HMC272AMS8 / 272AMS8E**

GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

# ROHS V

#### **MxN Spurious Outputs**

	nLO				
mRF	0	1	2	3	4
0	xx	-11	-6	5	19
1	7	0	37	27	38
2	53	64	62	46	72
3	83	>85	>85	>85	>85
4	>85	>85	>85	>85	>85

RF = 2.6 GHz @ -10 dBm LO = 2.2 GHz @ +13 dBm All values in dBc relative to the IF

#### Harmonics of LO

	nLO Spur at RF Port			
LO Frequency (GHz)	1	2	3	4
1.5	37	14	36	41
1.7	35	12	37	48
1.9	35	13	43	49
2.1	43	16	42	49
2.3	36	19	37	49
2.5	29	23	36	50

LO = +10 dBm Values in dBc below input LO level measured at the RF port.

#### **Absolute Maximum Ratings**

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



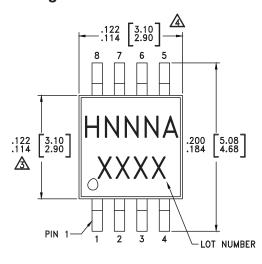


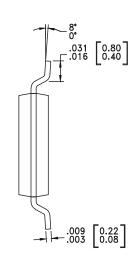
# **HMC272AMS8 / 272AMS8E**

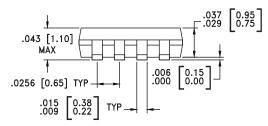
GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz



#### **Outline Drawing**







#### NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

  A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
  - 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

# Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC272AMS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H272A XXXX
HMC272AMS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H272A XXXX

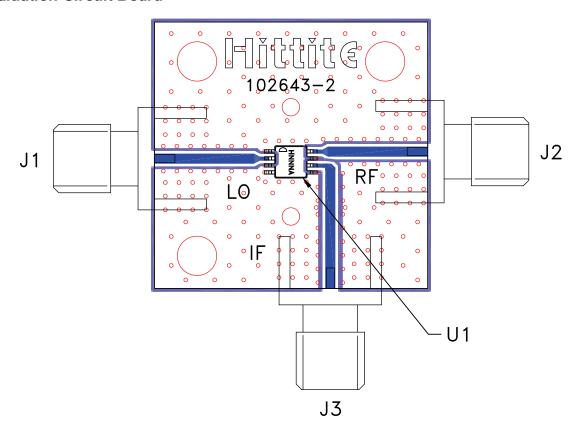
- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260  $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX





# GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

#### **Evaluation Circuit Board**



#### List of Materials for Evaluation PCB 102781 [1]

Item	Description	
J1 - J3	PCB Mount SMA RF Connector	
U1	HMC272AMS8 / HMC272AMS8E Mixer	
PCB [2]	102643 Evaluation Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.